Deep Learning-Enhanced Structural Health Monitoring

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Message from the Guest Editors

This Special Issue calls for high-quality original research articles, review articles, and technical notes focused on such emergent technologies and the latest advances in the field. Topics may cover broad areas related to the development or enhancement of applied methodologies, new SHM architectures, wireless sensing networks, smart devices, optimal sensors placement, issues related to structural implementation, synthetic data generation and processing, and inter-disciplinary applications.

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Special Issue

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Message from the Editor-in-Chief

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